

## DIGITAL TV TUNER IC

### FEATURES

- Integrated Mixer/Oscillator/PLL and IF GCA
- VHF-L, VHF-H, UHF 3-Band Local Oscillator
- RF AGC Detector Circuit
- I<sup>2</sup>C Bus Protocol  
Bidirectional Data Transmission
- High-Voltage Tuning Voltage Output
- Four NPN-Type Band Switch Drivers
- One Auxiliary Port/5-Level ADC
- Crystal Oscillator Output
- Programmable Reference Divider Ratio  
(24/28/32/64/80/128)
- IF GCA Enable/Disable Control
- Selectable digital IFOUT and Analog IFOUT
- Standby Mode
- 5-V Power Supply
- 44-Pin Thin Shrink Small-Outline Package  
(TSSOP)

### APPLICATIONS

- Digital TVs
- Digital CATVs
- Set-Top Boxes

### DESCRIPTION

The SN761640 is a low-phase-noise synthesized tuner IC designed for digital TV tuning systems. The circuit consists of a PLL synthesizer, three-band local oscillator and mixer, RF AGC detector circuit, and IF gain-controlled amplifier. The SN761640 is available in a small-outline package.

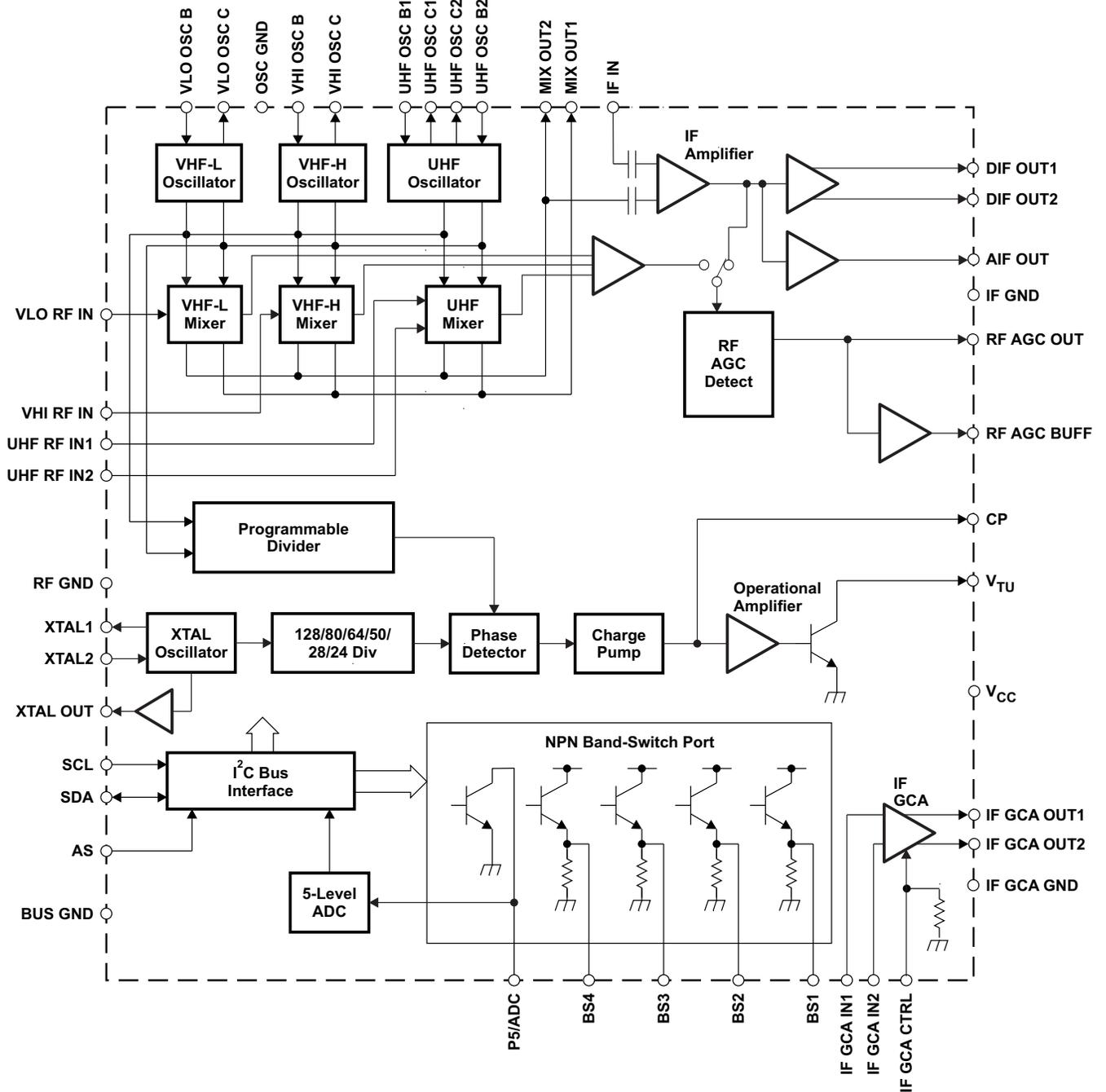
**DBT PACKAGE  
(TOP VIEW)**

VLO OSC B	1	44	BS4
VLO OSC C	2	43	UHF RF IN1
VHI OSC B	3	42	UHF RF IN2
VHI OSC C	4	41	VHI RF IN
UHF OSC B1	5	40	VLO RF IN
UHF OSC C1	6	39	RF GND
UHF OSC C2	7	38	MIX OUT2
UHF OSC B2	8	37	MIX OUT1
OSC GND	9	36	IF IN
CP	10	35	RF AGC OUT
VTU	11	34	RF AGC BUF
IF GND	12	33	BS3
AIF OUT	13	32	BS2
DIF OUT1	14	31	BS1
DIF OUT2	15	30	SDA
IFGCA CTRL	16	29	SCL
VCC	17	28	AS
IF GCA IN1	18	27	BUS GND
IF GCA IN2	19	26	P5/ADC
IF GCA GND	20	25	XTAL OUT
IF GCA OUT2	21	24	XTAL2
IF GCA OUT1	22	23	XTAL1



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

FUNCTIONAL BLOCK DIAGRAM



## TERMINAL FUNCTIONS

TERMINAL		DESCRIPTION	SCHEMATIC
NAME	NO.		
AIF OUT	13	IF amplifier output (analog)	<a href="#">Figure 8</a>
AS	28	Address selection input	<a href="#">Figure 1</a>
BS1	31	Band switch 1 output	<a href="#">Figure 2</a>
BS2	32	Band switch 2 output	<a href="#">Figure 2</a>
BS3	33	Band switch 3 output	<a href="#">Figure 2</a>
BS4	44	Band switch 4 output	<a href="#">Figure 2</a>
BUS GND	27	BUS ground	
CP	10	Charge-pump output	<a href="#">Figure 3</a>
DIF OUT1	14	IF amplifier output 1	<a href="#">Figure 9</a>
DIF OUT2	15	IF amplifier output 2	<a href="#">Figure 9</a>
IF GCA CTRL	16	IF GCA CTRL voltage inout	<a href="#">Figure 4</a>
IF GCA GND	20	IF GCA ground	
IF GCA IN1	18	IF GCA input 1	<a href="#">Figure 5</a>
IF GCA IN2	19	IF GCA input 2	<a href="#">Figure 5</a>
IF GCA OUT1	22	IF GCA output 1	<a href="#">Figure 6</a>
IF GCA OUT2	21	IF GCA output 2	<a href="#">Figure 6</a>
IF GND	12	IF ground	
IF IN	36	IF amplifier input	<a href="#">Figure 7</a>
MIXOUT1	37	Mixer output 1	<a href="#">Figure 10</a>
MIXOUT2	38	Mixer output 2	<a href="#">Figure 10</a>
OSC GND	9	Oscillator ground	
P5/ADC	26	Port-5 output/ADC input	<a href="#">Figure 11</a>
RF AGC BUF	34	RF AGC buffer output	<a href="#">Figure 12</a>
RF AGC OUT	35	RF AGC output	<a href="#">Figure 13</a>
RF GND	39	RF ground	
SCL	29	Serial clock input	<a href="#">Figure 14</a>
SDA	30	Serial data input/output	<a href="#">Figure 15</a>
UHF OSC B1	5	UHF oscillator base 1	<a href="#">Figure 16</a>
UHF OSC B2	8	UHF oscillator base 2	<a href="#">Figure 16</a>
UHF OSC C1	6	UHF oscillator collector 1	<a href="#">Figure 16</a>
UHF OSC C2	7	UHF oscillator collector 2	<a href="#">Figure 16</a>
UHF RF IN1	43	UHF RF input 1	<a href="#">Figure 17</a>
UHF RF IN2	42	UHF RF input 2	<a href="#">Figure 17</a>
V <sub>CC</sub>	17	Supply voltage for mixer/oscillator/PLL: 5 V	
VHI OSC B	3	VHF-H oscillator base	<a href="#">Figure 18</a>
VHI OSC C	4	VHF-H oscillator collector	<a href="#">Figure 18</a>
VHI RF IN	41	VHF-H RF input	<a href="#">Figure 19</a>
VLO OSC B	1	VHF-L oscillator base	<a href="#">Figure 20</a>
VLO OSC C	2	VHF-L oscillator collector	<a href="#">Figure 20</a>
VLO RF IN	40	VHF-L RF input	<a href="#">Figure 21</a>
VTU	11	Tuning voltage amplifier output	<a href="#">Figure 3</a>
XTAL1	23	4-MHz crystal oscillator output	<a href="#">Figure 22</a>
XTAL2	24	4-MHz crystal oscillator input	<a href="#">Figure 22</a>
XTALOUT	25	4-MHz crystal oscillator buffer output	<a href="#">Figure 23</a>

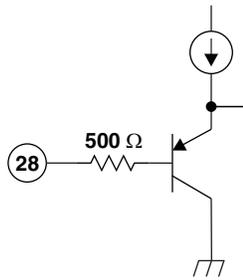


Figure 1. AS

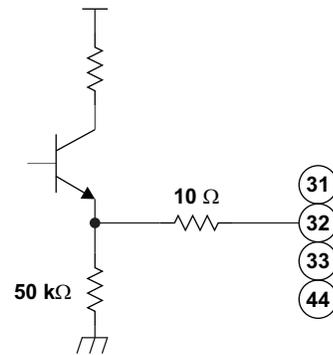


Figure 2. BS1, BS2, BS3, and BS4

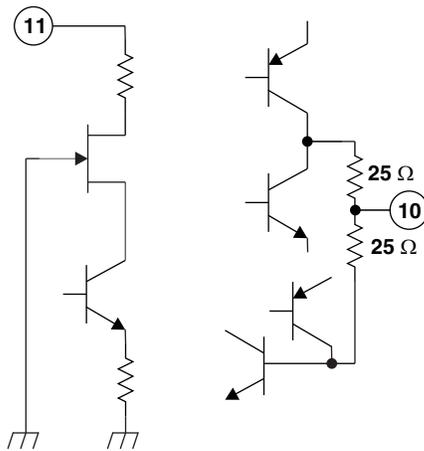


Figure 3. CP and VTU

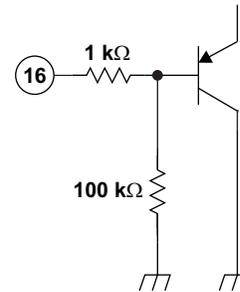


Figure 4. IF GCA CTRL

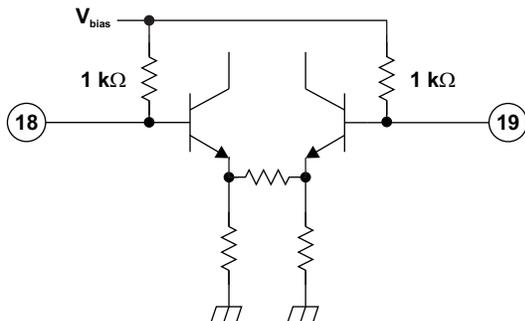


Figure 5. IF GCA IN1 and IF GCA IN2

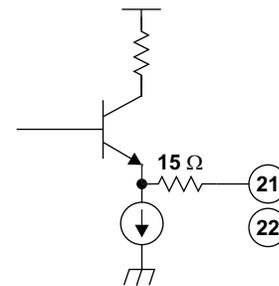


Figure 6. IF GCA OUT1 and IF GCA OUT2

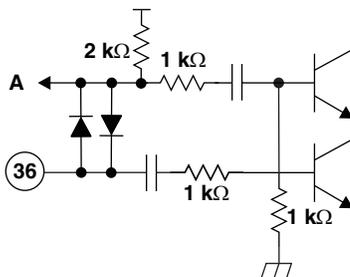


Figure 7. IF IN

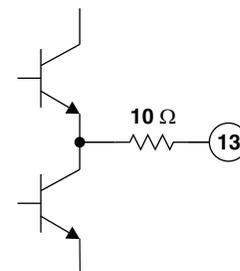


Figure 8. AIF OUT

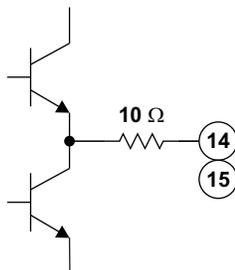


Figure 9. DIF OUT1 and DIF OUT2

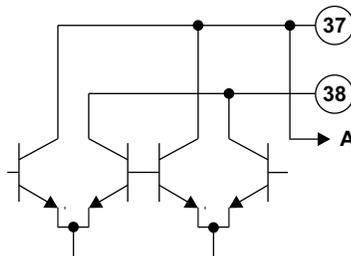


Figure 10. MIXOUT1 and MIXOUT2

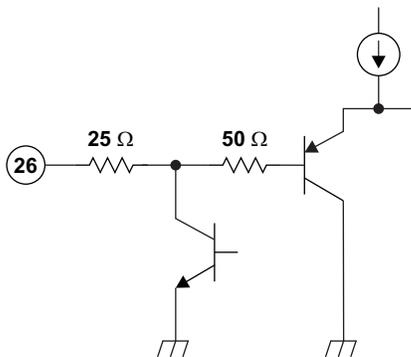


Figure 11. P5/ADC

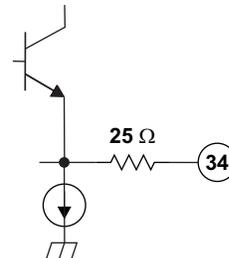


Figure 12. RF AGC BUF

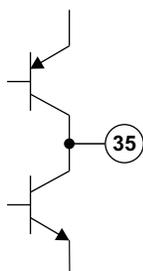


Figure 13. RF AGC OUT

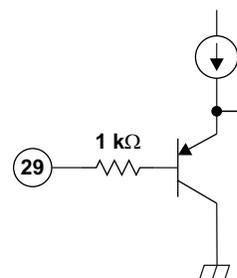


Figure 14. SCL

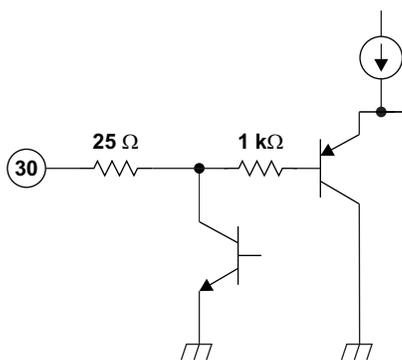


Figure 15. SDA

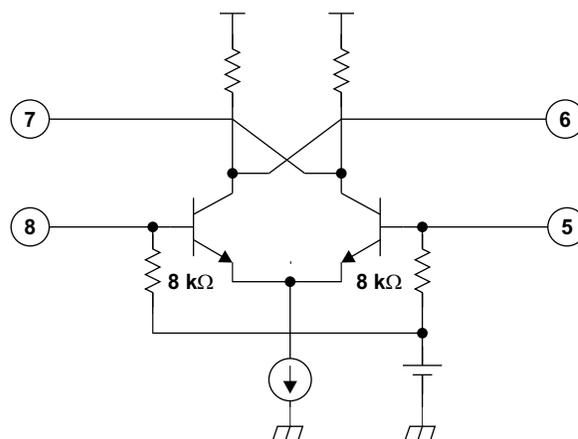


Figure 16. UHF OSC B1, UHF OSC B2, UHF OSC C1, and UHF OSC C2

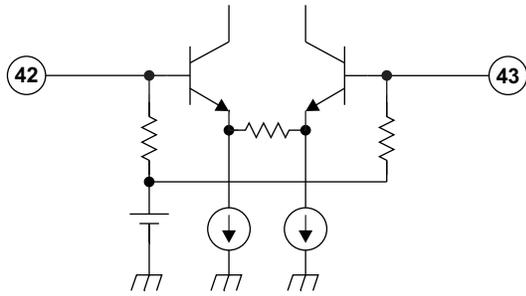


Figure 17. UHF RF IN1 and UHF RF IN2

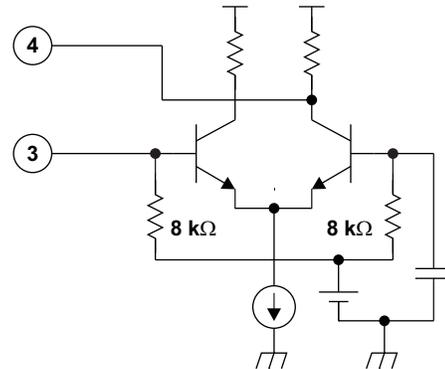


Figure 18. VHI OSC B and VHI OSC C

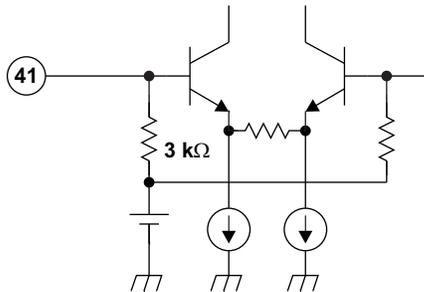


Figure 19. VHI RF IN

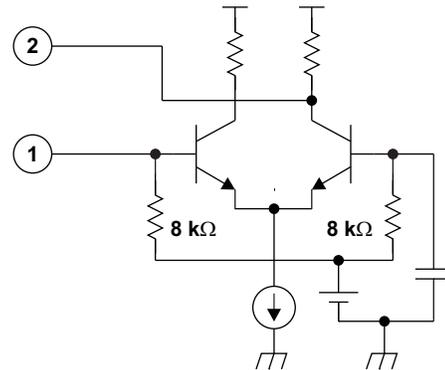


Figure 20. VLO OSC B and VLO OSC C

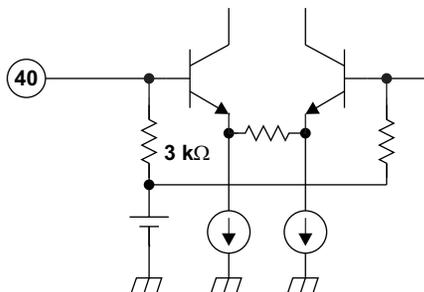


Figure 21. VLO RF IN

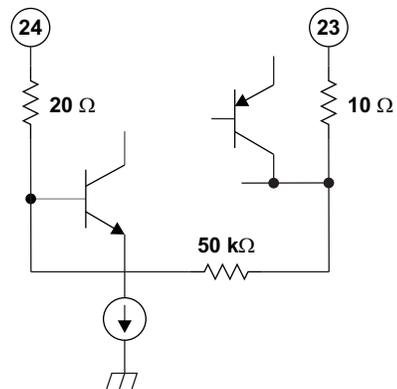


Figure 22. XTAL1 and XTAL2

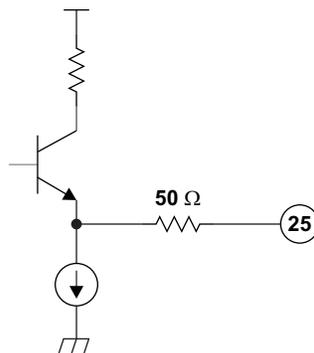


Figure 23. XTALOUT

## ABSOLUTE MAXIMUM RATINGS<sup>(1)</sup>

over recommended operating free-air temperature range (unless otherwise noted)

			MIN	MAX	UNIT
V <sub>CC</sub>	Supply voltage range <sup>(2)</sup>	V <sub>CC</sub>	-0.4	6.5	V
V <sub>GND</sub>	Input voltage range 1 <sup>(2)</sup>	RF GND, OSC GND	-0.4	0.4	V
VTU	Input voltage range 2 <sup>(2)</sup>	VTU	-0.4	35	V
V <sub>IN</sub>	Input voltage range 3 <sup>(2)</sup>	Other pins	-0.4	6.5	V
P <sub>D</sub>	Continuous total dissipation <sup>(3)</sup>	T <sub>A</sub> ≤ 25°C		1438	mW
T <sub>A</sub>	Operating free-air temperature range		-20	85	°C
T <sub>stg</sub>	Storage temperature range		-65	150	°C
T <sub>J</sub>	Maximum junction temperature			150	°C
t <sub>SC(max)</sub>	Maximum short-circuit time	Each pin to V <sub>CC</sub> or to GND		10	s

- (1) Stresses beyond those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under *Recommended Operating Conditions* is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) Voltage values are with respect to the IF GND of the circuit.
- (3) Derating factor is 11.5 mW/°C for T<sub>A</sub> ≥ 25°C.

## RECOMMENDED OPERATING CONDITIONS

			MIN	NOM	MAX	UNIT
V <sub>CC</sub>	Supply voltage	V <sub>CC</sub>	4.5	5	5.5	V
VTU	Tuning supply voltage	VTU		30	33	V
I <sub>BS</sub>	Output current of band switch	BS1 – BS4, one band switch on			10	mA
I <sub>P5</sub>	Output current of port 5	P5/ADC			-5	mA
T <sub>A</sub>	Operating free-air temperature		-20		85	°C



This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

IF IN1, MIXOUT1, and MIXOUT2 (pins 36–38) withstand 1.5 kV, and all other pins withstand 2 kV, according to the Human-Body Model (1.5 kΩ, 100 pF).

## ELECTRICAL CHARACTERISTICS

### Total Device and Serial Interface

$V_{CC} = 4.5\text{ V to }5.5\text{ V}$ ,  $T_A = -20^\circ\text{C to }85^\circ\text{C}$  (unless otherwise noted)

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
$I_{CC1}$	Supply current 1	BS[1:4] = 0100, IFGCA disabled		90	120	mA
$I_{CC2}$	Supply current 2	BS[1:4] = 0100, IFGCA enabled		115	145	mA
$I_{CC3}$	Supply current 3	BS[1:4] = 0100, IFGCA enabled, $I_{BS} = 10\text{ mA}$		125	155	mA
$I_{CC-STBY}$	Standby supply current	BS[1:4] = 1100		9		mA
$V_{IH}$	High-level input voltage (SCL, SDA)		2.3			V
$V_{IL}$	Low-level input voltage (SCL, SDA)				1.05	V
$I_{IH}$	High-level input current (SCL, SDA)				10	$\mu\text{A}$
$I_{IL}$	Low-level input current (SCL, SDA)		-10			$\mu\text{A}$
$V_{POR}$	Power-on-reset supply voltage (threshold of supply voltage between reset and operation mode)		2.1	2.8	3.5	V
<b>I<sup>2</sup>C Interface</b>						
$V_{ASH}$	Address-select high-input voltage (AS)	$V_{CC} = 5\text{ V}$	4.5		5	V
$V_{ASM1}$	Address-select mid-input 1 voltage (AS)	$V_{CC} = 5\text{ V}$	2		3	V
$V_{ASM2}$	Address-select mid-input 2 voltage (AS)	$V_{CC} = 5\text{ V}$	1		1.5	V
$V_{ASL}$	Address-select low-input voltage (AS)	$V_{CC} = 5\text{ V}$			0.5	V
$I_{ASH}$	Address-select high-input current (AS)				50	$\mu\text{A}$
$I_{ASL}$	Address-select low-input current (AS)		-10			$\mu\text{A}$
$V_{ADC}$	ADC input voltage	See <a href="#">Table 10</a>	0		$V_{CC}$	V
$I_{ADH}$	ADC high-level input current	$V_{ADC} = V_{CC}$			10	$\mu\text{A}$
$I_{ADL}$	ADC low-level input current	$V_{ADC} = 0\text{ V}$	-10			$\mu\text{A}$
$V_{OL}$	Low-level output voltage (SDA)	$V_{CC} = 5\text{ V}$ , $I_{OL} = 3\text{ mA}$			0.4	V
$I_{SDAH}$	High-level output leakage current (SDA)	$V_{SDA} = 5.5\text{ V}$			10	$\mu\text{A}$
$f_{SCL}$	Clock frequency (SCL)			100	400	kHz
$t_{HD-DAT}$	Data hold time	See <a href="#">Figure 24</a>	0		0.9	$\mu\text{s}$
$t_{BUF}$	Bus free time		1.3			$\mu\text{s}$
$t_{HD-STA}$	Start hold time		0.6			$\mu\text{s}$
$t_{LOW}$	SCL-low hold time		1.3			$\mu\text{s}$
$t_{HIGH}$	SCL-high hold time		0.6			$\mu\text{s}$
$t_{SU-STA}$	Start setup time		0.6			$\mu\text{s}$
$t_{SU-DAT}$	Data setup time		0.1			$\mu\text{s}$
$t_r$	Rise time (SCL, SDA)				0.3	$\mu\text{s}$
$t_f$	Fall time (SCL, SDA)				0.3	$\mu\text{s}$
$t_{SU-STO}$	Stop setup time		0.6			$\mu\text{s}$

## PLL and Band Switch

 $V_{CC} = 4.5\text{ V to }5.5\text{ V}$ ,  $T_A = -20^\circ\text{C to }85^\circ\text{C}$  (unless otherwise noted)

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
N	Divider ratio	15-bit frequency word	512		32767	
$f_{XTAL}$	Crystal oscillator frequency	$R_{XTAL} = 25\ \Omega$ to $300\ \Omega$		4		MHz
$Z_{XTAL}$	Crystal oscillator input impedance		1.6	2.4		k $\Omega$
$V_{XLO}$	XTALOUT output voltage	Load = $10\text{ pF}/5.1\text{ k}\Omega$ , $V_{CC} = 5\text{ V}$ , $T_A = 25^\circ\text{C}$		0.4		V <sub>p-p</sub>
$V_{VTUL}$	Tuning amplifier low-level output voltage	$R_L = 20\text{ k}\Omega$ , $VTU = 33\text{ V}$	0.2	0.3	0.46	V
$I_{VTUOFF}$	Tuning amplifier leakage current	Tuning amplifier = off, $VTU = 33\text{ V}$			10	$\mu\text{A}$
$I_{CP11}$	Charge-pump current	CP[2:0] = 011		600		$\mu\text{A}$
$I_{CP10}$		CP[2:0] = 010		350		
$I_{CP01}$		CP[2:0] = 001		140		
$I_{CP00}$		CP[2:0] = 000		70		
$I_{CP100}$		CP[2:0] = 100, Mode = 1		900		
$V_{CP}$	Charge-pump output voltage	PLL locked		1.95		V
$I_{CPOFF}$	Charge-pump leakage current	$V_{CP} = 2\text{ V}$ , $T_A = 25^\circ\text{C}$	-15		15	nA
$I_{BS}$	Band switch driver output current (BS1–BS4)				10	mA
$V_{BS1}$	Band switch driver output voltage (BS1–BS4)	$I_{BS} = 10\text{ mA}$		3		V
$V_{BS2}$		$I_{BS} = 10\text{ mA}$ , $V_{CC} = 5\text{ V}$ , $T_A = 25^\circ\text{C}$		3.5	3.7	
$I_{BSOFF}$	Band switch driver leakage current (BS1–BS4)	$V_{BS} = 0\text{ V}$			8	$\mu\text{A}$
$I_{P5}$	Band switch port sink current (P5/ADC)				-5	mA
$V_{P5ON}$	Band switch port output voltage (P5/ADC)	$I_{P5} = -2\text{ mA}$ , $V_{CC} = 5\text{ V}$ , $T_A = 25^\circ\text{C}$			0.6	V

## RF AGC<sup>(1)</sup>

 $V_{CC} = 5\text{ V}$ ,  $T_A = 25^\circ\text{C}$ , measured in [Figure 25](#) reference measurement circuit at 50- $\Omega$  system,  $IF = 44\text{ MHz}$ ,  
 IF filter characteristics:  $f_{peak} = 44\text{ MHz}$  (unless otherwise noted)

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
$I_{OAGC0}$	RF AGC output source current	ATC = 0		300		nA
$I_{OAGC1}$		ATC = 1		9		$\mu\text{A}$
$I_{OAGCSINK}$	RF AGC peak sink current	ATC = 0		100		$\mu\text{A}$
$V_{OAGCH}$	RFAGCOUT output high voltage (max level)	ATC = 1	3.5	4	4.5	V
$V_{OAGCL}$	RFAGCOUT output low voltage (min level)	ATC = 1		0.3		V
$I_{AGCBUF}$	RFAGCBUF output current	ATC = 0		1.5		mA
$V_{OAGCBFH}$	RFAGCBUF output high voltage (max level)	ATC = 1	3.5	4	4.5	V
$V_{OAGCBFL}$	RFAGCBUF output low voltage (min level)	ATC = 1		0.3		V
$V_{AGCSP00}$	Start-point IF output level	ATP[2:0] = 000		114		dB $\mu\text{V}$
$V_{AGCSP01}$		ATP[2:0] = 001		112		
$V_{AGCSP02}$		ATP[2:0] = 010		110		
$V_{AGCSP03}$		ATP[2:0] = 011		108		
$V_{AGCSP04}$		ATP[2:0] = 100		106		
$V_{AGCSP05}$		ATP[2:0] = 101		104		
$V_{AGCSP06}$		ATP[2:0] = 110		102		

(1) When AISL=1, RF AGC function is not available at VHF-L band (output level is undefined).

## Mixer, Oscillator, IF Amplifier (DIF OUT)

$V_{CC} = 5\text{ V}$ ,  $T_A = 25^\circ\text{C}$ , measured in [Figure 25](#) reference measurement circuit at 50- $\Omega$  system, IF = 44 MHz, IF filter characteristics:  $f_{\text{peak}} = 44\text{ MHz}$  (unless otherwise noted)

PARAMETER		TEST CONDITIONS	TYP	UNIT
$G_{C1D}$	Conversion gain (mixer-IF amplifier), VHF-LOW	$f_{\text{in}} = 57\text{ MHz}^{(1)}$	35	dB
$G_{C3D}$		$f_{\text{in}} = 171\text{ MHz}^{(1)}$	35	
$G_{C4D}$	Conversion gain (mixer-IF amplifier), VHF-HIGH	$f_{\text{in}} = 177\text{ MHz}^{(1)}$	35	dB
$G_{C6D}$		$f_{\text{in}} = 467\text{ MHz}^{(1)}$	35	
$G_{C7D}$	Conversion gain (mixer-IF amplifier), UHF	$f_{\text{in}} = 473\text{ MHz}^{(1)}$	35	dB
$G_{C9D}$		$f_{\text{in}} = 864\text{ MHz}^{(1)}$	35	
$NF_{1D}$	Noise figure, VHF-LOW	$f_{\text{in}} = 57\text{ MHz}$	9	dB
$NF_{3D}$		$f_{\text{in}} = 171\text{ MHz}$	9	
$NF_{4D}$	Noise figure, VHF-HIGH	$f_{\text{in}} = 177\text{ MHz}$	9	dB
$NF_{6D}$		$f_{\text{in}} = 467\text{ MHz}$	10	
$NF_{7D}$	Noise figure, UHF	$f_{\text{in}} = 473\text{ MHz}$	10	dB
$NF_{9D}$		$f_{\text{in}} = 864\text{ MHz}$	12	
$CM_{1D}$	Input voltage causing 1% cross-modulation distortion, VHF-LOW	$f_{\text{in}} = 57\text{ MHz}^{(2)}$	79	dB $\mu$ V
$CM_{3D}$		$f_{\text{in}} = 171\text{ MHz}^{(2)}$	79	
$CM_{4D}$	Input voltage causing 1% cross-modulation distortion, VHF-HIGH	$f_{\text{in}} = 177\text{ MHz}^{(2)}$	79	dB $\mu$ V
$CM_{6D}$		$f_{\text{in}} = 467\text{ MHz}^{(2)}$	79	
$CM_{7D}$	Input voltage causing 1% cross-modulation distortion, UHF	$f_{\text{in}} = 473\text{ MHz}^{(2)}$	77	dB $\mu$ V
$CM_{9D}$		$f_{\text{in}} = 864\text{ MHz}^{(2)}$	77	
$V_{\text{IFO1D}}$	IF output voltage, VHF-LOW	$f_{\text{in}} = 57\text{ MHz}$	117	dB $\mu$ V
$V_{\text{IFO3D}}$		$f_{\text{in}} = 171\text{ MHz}$	117	
$V_{\text{IFO4D}}$	IF output voltage, VHF-HIGH	$f_{\text{in}} = 177\text{ MHz}$	117	dB $\mu$ V
$V_{\text{IFO6D}}$		$f_{\text{in}} = 467\text{ MHz}$	117	
$V_{\text{IFO7D}}$	IF output voltage, UHF	$f_{\text{in}} = 473\text{ MHz}$	117	dB $\mu$ V
$V_{\text{IFO9D}}$		$f_{\text{in}} = 864\text{ MHz}$	117	
$\Phi_{\text{PLVL1D}}$	Phase noise, VHF-LOW	$f_{\text{in}} = 57\text{ MHz}^{(3)}$	-90	dBc/Hz
$\Phi_{\text{PLVL3D}}$		$f_{\text{in}} = 171\text{ MHz}^{(4)}$	-85	
$\Phi_{\text{PLVL4D}}$	Phase noise, VHF-HIGH	$f_{\text{in}} = 177\text{ MHz}^{(3)}$	-85	dBc/Hz
$\Phi_{\text{PLVL6D}}$		$f_{\text{in}} = 467\text{ MHz}^{(4)}$	-77	
$\Phi_{\text{PLVL7D}}$	Phase noise, UHF	$f_{\text{in}} = 473\text{ MHz}^{(3)}$	-80	dBc/Hz
$\Phi_{\text{PLVL9D}}$		$f_{\text{in}} = 864\text{ MHz}^{(4)}$	-77	

- (1) IF = 44 MHz, RF input level = 70 dB $\mu$ V, differential output  
(2)  $f_{\text{undes}} = f_{\text{des}} \pm 6\text{ MHz}$ ,  $P_{\text{in}} = 70\text{ dB}\mu\text{V}$ , AM 1 kHz, 30%, DES/CM = S/I = 46 dB  
(3) Offset = 1 kHz, CP current = 350  $\mu$ A, reference divider = 64  
(4) Offset = 1 kHz, CP current = 900  $\mu$ A, reference divider = 64

**Mixer, Oscillator, IF Amplifier (AIF OUT)**

$V_{CC} = 5\text{ V}$ ,  $T_A = 25^\circ\text{C}$ , measured in [Figure 25](#) reference measurement circuit at 50- $\Omega$  system, IF = 45.75 MHz,  
 IF filter characteristics:  $f_{\text{peak}} = 44\text{ MHz}$  (unless otherwise noted)

PARAMETER		TEST CONDITIONS	TYP	UNIT
$G_{C1A}$	Conversion gain (mixer-IF amplifier), VHF-LOW	$f_{\text{in}} = 55.25\text{ MHz}^{(1)}$	29	dB
$G_{C3A}$		$f_{\text{in}} = 169.25\text{ MHz}^{(1)}$	29	
$G_{C4A}$	Conversion gain (mixer-IF amplifier), VHF-HIGH	$f_{\text{in}} = 175.25\text{ MHz}^{(1)}$	29	dB
$G_{C6A}$		$f_{\text{in}} = 465.25\text{ MHz}^{(1)}$	29	
$G_{C7A}$	Conversion gain (mixer-IF amplifier), UHF	$f_{\text{in}} = 471.25\text{ MHz}^{(1)}$	29	dB
$G_{C9A}$		$f_{\text{in}} = 862.25\text{ MHz}^{(1)}$	29	
$NF_{1A}$	Noise figure, VHF-LOW	$f_{\text{in}} = 55.25\text{ MHz}$	9	dB
$NF_{3A}$		$f_{\text{in}} = 169.25\text{ MHz}$	9	
$NF_{4A}$	Noise figure, VHF-HIGH	$f_{\text{in}} = 175.25\text{ MHz}$	9	dB
$NF_{6A}$		$f_{\text{in}} = 465.25\text{ MHz}$	10	
$NF_{7A}$	Noise figure, UHF	$f_{\text{in}} = 471.25\text{ MHz}$	10	dB
$NF_{9A}$		$f_{\text{in}} = 862.25\text{ MHz}$	12	
$CM_{1A}$	Input voltage causing 1% cross-modulation distortion, VHF-LOW	$f_{\text{in}} = 55.25\text{ MHz}^{(2)}$	79	dB $\mu$ V
$CM_{3A}$		$f_{\text{in}} = 169.25\text{ MHz}^{(2)}$	79	
$CM_{4A}$	Input voltage causing 1% cross-modulation distortion, VHF-HIGH	$f_{\text{in}} = 175.25\text{ MHz}^{(2)}$	79	dB $\mu$ V
$CM_{6A}$		$f_{\text{in}} = 465.25\text{ MHz}^{(2)}$	79	
$CM_{7A}$	Input voltage causing 1% cross-modulation distortion, UHF	$f_{\text{in}} = 471.25\text{ MHz}^{(2)}$	79	dB $\mu$ V
$CM_{9A}$		$f_{\text{in}} = 862.25\text{ MHz}^{(2)}$	77	
$V_{\text{IFO1A}}$	IF output voltage, VHF-LOW	$f_{\text{in}} = 55.25\text{ MHz}$	117	dB $\mu$ V
$V_{\text{IFO3A}}$		$f_{\text{in}} = 169.25\text{ MHz}$	117	
$V_{\text{IFO4A}}$	IF output voltage, VHF-HIGH	$f_{\text{in}} = 175.25\text{ MHz}$	117	dB $\mu$ V
$V_{\text{IFO6A}}$		$f_{\text{in}} = 465.25\text{ MHz}$	117	
$V_{\text{IFO7A}}$	IF output voltage, UHF	$f_{\text{in}} = 471.25\text{ MHz}$	117	dB $\mu$ V
$V_{\text{IFO9A}}$		$f_{\text{in}} = 862.25\text{ MHz}$	117	
$\Phi_{\text{PLVL1A}}$	Phase noise, VHF-LOW	$f_{\text{in}} = 55.25\text{ MHz}^{(3)}$	-95	dBc/Hz
$\Phi_{\text{PLVL3A}}$		$f_{\text{in}} = 169.25\text{ MHz}^{(3)}$	-95	
$\Phi_{\text{PLVL4A}}$	Phase noise, VHF-HIGH	$f_{\text{in}} = 175.25\text{ MHz}^{(3)}$	-90	dBc/Hz
$\Phi_{\text{PLVL6A}}$		$f_{\text{in}} = 465.25\text{ MHz}^{(3)}$	-90	
$\Phi_{\text{PLVL7A}}$	Phase noise, UHF	$f_{\text{in}} = 471.25\text{ MHz}^{(3)}$	-85	dBc/Hz
$\Phi_{\text{PLVL9A}}$		$f_{\text{in}} = 862.25\text{ MHz}^{(3)}$	-90	

- (1) IF = 44 MHz, RF input level = 70 dB $\mu$ V, differential output  
 (2)  $f_{\text{undes}} = f_{\text{des}} \pm 6\text{ MHz}$ ,  $P_{\text{in}} = 70\text{ dB}\mu\text{V}$ , AM 1 kHz, 30%, DES/CM = S/I = 46 dB  
 (3) Offset = 10 kHz, CP current = 70  $\mu$ A, reference divider = 128

## IF Gain Controlled Amplifier

$V_{CC} = 5\text{ V}$ ,  $T_A = 25^\circ\text{C}$ , measured in [Figure 25](#) reference measurement circuit at 50- $\Omega$  system,  $f = 44\text{ MHz}$  (unless otherwise noted)

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
$I_{IFGCA}$	Input current (IF GCA CTRL)	$V_{IFGCA} = 3\text{ V}$		30	60	$\mu\text{A}$
$V_{IFGCAMAX}$	Maximum gain control voltage	Gain maximum	3		$V_{CC}$	V
$V_{IFGCAMIN}$	Minimum gain control voltage	Gain minimum	0		0.2	V
$G_{IFGCAMAX}$	Maximum gain	$V_{IFGCA} = 3\text{ V}$		65		dB
$G_{IFGCAMIN}$	Minimum gain	$V_{IFGCA} = 0\text{ V}$		-1		dB
$GCR_{IFGCA}$	Gain control range	$V_{IFGCA} = 0\text{ V to }3\text{ V}$		66		dB
$V_{IFGCAOUT}$	Output voltage	Single-ended output, $V_{IFGCA} = 3\text{ V}$		2.1		Vp-p
$NF_{IFGCA}$	Noise figure	$V_{IFGCA} = 3\text{ V}$		8.5		dB
$IM3_{IFGCA}$	Third order intermodulation distortion	$f_{IFGCAIN1} = 43\text{ MHz}$ , $f_{IFGCAIN2} = 44\text{ MHz}$ , $V_{IFGCAOUT} = -2\text{ dBm}$ , $V_{IFGCA} = 3\text{ V}$		-50		dBc
$IIP3_{IFGCA}$	Input intercept point	$V_{IFGCA} = 0\text{ V}$		11		dBm
$R_{IFGCAIN}$	Input resistance (IF GCA IN1, IF GCA IN2)			1		k $\Omega$
$R_{IFGCAOUT}$	Output resistance (IF GCA OUT1, IF GCA OUT2)			25		$\Omega$

## FUNCTIONAL DESCRIPTION

### I<sup>2</sup>C Bus Mode

#### I<sup>2</sup>C Write Mode (R/W = 0)

**Table 1. Write Data Format**

	MSB							LSB	
Address byte (ADB)	1	1	0	0	0	MA1	MA0	R/W = 0	A <sup>(1)</sup>
Divider byte 1 (DB1)	0	N14	N13	N12	N11	N10	N9	N8	A <sup>(1)</sup>
Divider byte 2 (DB2)	N7	N6	N5	N4	N3	N2	N1	N0	A <sup>(1)</sup>
Control byte 1 (CB1)	1	0	ATP2	ATP1	ATP0	RS2	RS1	RS0	A <sup>(1)</sup>
Band switch byte (BB)	CP1	CP0	AISL	P5	BS4	BS3	BS2	BS1	A <sup>(1)</sup>
Control byte 2 (CB2)	1	1	ATC	MODE	T3/DISGCA	T2/IFDA	T1/CP2	T0/XLO	A <sup>(1)</sup>

(1) A : acknowledge

**Table 2. Write Data Symbol Description**

SYMBOL	DESCRIPTION	DEFAULT															
MA[1:0]	Address-set bits (see <a href="#">Table 3</a> )																
N[14:0]	Programmable counter set bits $N = N14 \times 2^{14} + N13 \times 2^{13} + \dots + N1 \times 2 + N0$	N14 = N13 = N12 = ... = N0 = 0															
ATP[2:0]	RF AGC start-point control bits (see <a href="#">Table 4</a> )	ATP[2:0] = 000															
RS[2:0]	Reference divider ratio-selection bits (see <a href="#">Table 5</a> )	RS[2:0] = 000															
CP[1:0]	Charge-pump current-set bit (see <a href="#">Table 6</a> )	CP[1:0] = 00															
AISL	RF AGC detector input selection bit AISL = 0: IF amplifier AISL = 1: Mixer output	AISL = 0															
P5	Port output/ADC input control bit P5 = 0: ADC INPUT P5 = 1: Tr = ON	P5 = 0															
BS[4:1]	Band switch control bits BSn = 0: Tr = OFF BSn = 1: Tr = ON  Band selection by BS[1:2] <table style="margin-left: 20px;"> <thead> <tr> <th>BS1</th> <th>BS2</th> <th></th> </tr> </thead> <tbody> <tr> <td>1</td> <td>0</td> <td>VHF-LO</td> </tr> <tr> <td>0</td> <td>1</td> <td>VHF-HI</td> </tr> <tr> <td>0</td> <td>0</td> <td>UHF</td> </tr> <tr> <td>1</td> <td>1</td> <td>Standby mode/stop MOP function (XTALOUT is available in standby mode)</td> </tr> </tbody> </table>	BS1	BS2		1	0	VHF-LO	0	1	VHF-HI	0	0	UHF	1	1	Standby mode/stop MOP function (XTALOUT is available in standby mode)	BSn = 0
BS1	BS2																
1	0	VHF-LO															
0	1	VHF-HI															
0	0	UHF															
1	1	Standby mode/stop MOP function (XTALOUT is available in standby mode)															
ATC	RF AGC current-set bit ATC = 0: Current = 300 nA ATC = 1: Current = 9 μA	ATC = 0															
Mode T3/DISGCA T2/IFDA T1/CP2 T0/XLO	Mode = 0 : IFGCA enabled, DIFOUT1, 2 selected T3/DISGCA, T2/IFDA, T1/CP2, T0/XLO are Test bits and XTALOUT control bit (see <a href="#">Table 7</a> )  Mode = 1 T3/DISGCA = 0 : IF GCA enabled T3/DISGCA = 1 : IF GCA disabled T2/IFDA = 0 : DIFOUT1, 2 selected T2/IFDA = 1 : AIFOUT selected T1/CP2 : lcp control bit, See <a href="#">Table 6</a> T0/XLO = 0 : XTALOUT enabled T0/XLO = 1 : XTALOUT disabled	MODE = 0 T[3:0] = 0000															

**Table 3. Address Selection**

MA1	MA0	VOLTAGE APPLIED ON AS INPUT
0	0	0 V to 0.1 V <sub>CC</sub> (Low)
0	1	OPEN, or 0.2 V <sub>CC</sub> to 0.3 V <sub>CC</sub> (Mid2)
1	0	0.4 V <sub>CC</sub> to 0.6 V <sub>CC</sub> (Mid1)
1	1	0.9 V <sub>CC</sub> to V <sub>CC</sub> (High)

**Table 4. RF AGC Start Point<sup>(1)</sup>**

ATP2	ATP1	ATP0	IFOUT LEVEL (dBμV)
0	0	0	114
0	0	1	112
0	1	0	110
0	1	1	108
1	0	0	106
1	0	1	104
1	1	0	102
1	1	1	Disabled

(1) When AISL=1, RF AGC function is not available at VHF-L band (output level is undefined).

**Table 5. Reference Divider Ratio**

RS2	RS1	RS0	REFERENCE DIVIDER RATIO
0	0	0	24
0	0	1	28
0	1	0	32
0	1	1	64
1	0	0	128
1	X	1	80

**Table 6. Charge-Pump Current**

MODE	CP2	CP1	CP0	CHARGE PUMP CURRENT (μA)
X	0	0	0	70
X	0	0	1	140
X	0	1	0	350
X	0	1	1	600
1	1	0	0	900

**Table 7. Test Bits/XTALOUT Control <sup>(1)</sup>**

MODE	T3/DISGCA	T2/IFDA	T1/CP2	T0/XLO	DEVICE OPERATION	XTALOUT 4-MHz OUTPUT
0	0	0	0	0	Normal operation	Enabled
0	0	0	0	1	Normal operation	Disabled
1	X	X	X	0	Normal operation	Enabled
1	X	X	X	1	Normal operation	Disabled
0	X	1	X	X	Test mode	Not available
0	1	X	X	X	Test mode	Not available

(1) RFAGC and XTALOUT are not available in test mode.

### Example I<sup>2</sup>C Data Write Sequences

Telegram examples:

Start-ADB-DB1-DB2-CB1-BB-CB2-Stop  
Start-ADB-DB1-DB2-Stop  
Start-ADB-CB1-BB-CB2-Stop  
Start-ADB-CB1-BB-Stop  
Start-ADB-CB2-Stop

Abbreviations:

ADB: Address byte  
BB: Band switch byte  
CB1: Control byte 1  
CB2: Control byte 2  
DB1: Divider byte 1  
DB2: Divider byte 2  
Start: Start condition  
Stop: Stop condition

### I<sup>2</sup>C Read Mode ( $R/\overline{W} = 1$ )

**Table 8. Read Data Format**

	MSB							LSB	
Address byte (ADB)	1	1	0	0	0	MA1	MA0	$R/\overline{W} = 1$	A <sup>(1)</sup>
Status byte (SB)	POR	FL	1	1	X	A2	A1	A0	–

(1) A : acknowledge

**Table 9. Read Data Symbol Description**

SYMBOL	DESCRIPTION	DEFAULT
MA[1:0]	Address set bits (see <a href="#">Table 3</a> )	
POR	Power-on-reset flag POR set: power on POR reset: end-of-data transmission procedure	POR = 1
FL	In-lock flag PLL locked (FL = 1), unlocked (FL = 0)	
A[2:0]	Digital data of ADC (see <a href="#">Table 10</a> ) Bit P5 must be set to 0.	

Table 10. ADC Level<sup>(1)</sup>

A2	A1	A0	VOLTAGE APPLIED ON ADC INPUT
1	0	0	0.6 V <sub>CC</sub> to V <sub>CC</sub>
0	1	1	0.45 V <sub>CC</sub> to 0.6 V <sub>CC</sub>
0	1	0	0.3 V <sub>CC</sub> to 0.45 V <sub>CC</sub>
0	0	1	0.15 V <sub>CC</sub> to 0.3 V <sub>CC</sub>
0	0	0	0 V to 0.15 V <sub>CC</sub>

(1) Accuracy is  $0.03 \times V_{CC}$ .

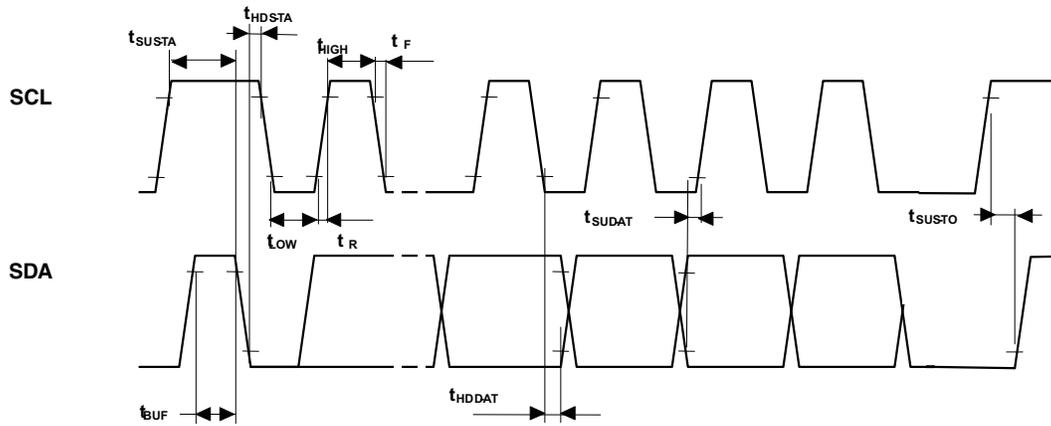
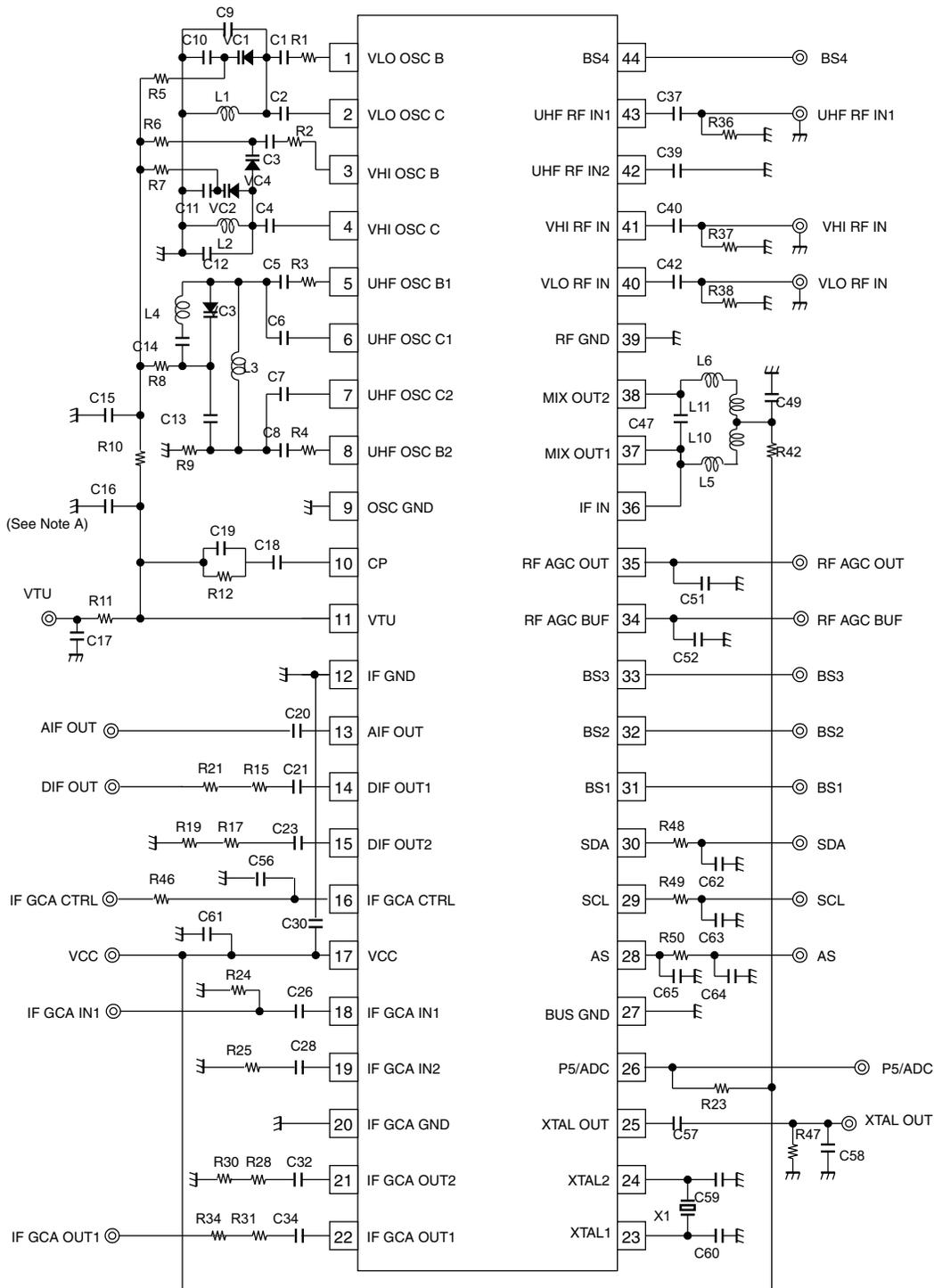


Figure 24. I<sup>2</sup>C Timing Chart

APPLICATION INFORMATION



- A. To prevent abnormal oscillation, connect C16, which does not affect a PLL.
- B. This application information is advisory and performance-check is required at actual application circuits. TI assumes no responsibility for the consequences of use of this circuit, such as an infringement of intellectual property rights or other rights, including patents, of third parties.

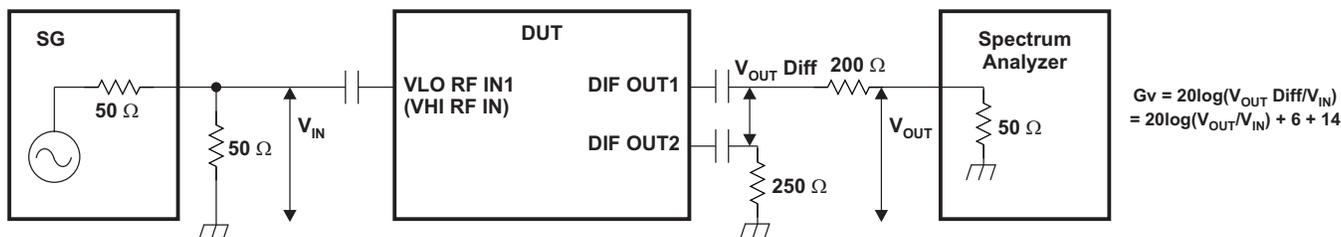
Figure 25. Reference Measurement Circuit

### Component Values for Measurement Circuit

PARTS NAME	VALUE	PARTS NAME	VALUE
C1 (VLO OSC B)	1 pF	L1 (VLO OSC)	3.0 mm, 7T, wire 0.32 mm
C2 (VLO OSC C)	2 pF	L2 (VHI OSC)	2.0 mm, 3T, wire 0.4 mm
C3 (VHI OSC B)	7 pF	L3 (UHF OSC)	1.8 mm, 3T, wire 0.4 mm
C4 (VHI OSC C)	5 pF	L4 (UHF OSC)	1.8 mm, 3T, wire 0.4 mm
C5 (UHF OSCB1)	1.5 pF	L5 (MIX OUT)	680 nH (LK1608R68K-T)
C6 (UHF OSCC1)	1 pF	L6 (MIX OUT)	680 nH (LK1608R68K-T)
C7 (UHF OSCC2)	1 pF	L10 (MIX OUT)	Short
C8 (UHF OSCB2)	1.5 pF	L11 (MIX OUT)	Short
C9 (VLO OSC)	OPEN	R1(VLO OSC B)	0
C10(VLO OSC)	43 pF	R2 (VHI OSC B)	4.7 Ω
C11 (VHI OSC)	51 pF	R3 (UHF OSC B1)	4.7 Ω
C12 (VHI OSC)	0.5 pF	R4 (UHF OSC B2)	0
C13 (UHF OSC)	10 pF	R5 (VLO OSC)	3.3 kΩ
C14 (UHF OSC)	100 pF	R6 (VHI OSC)	3.3 kΩ
C15 (VTU)	2.2 nF/50 V	R7 (VHI OSC)	3.3 kΩ
C16 (CP)	150 pF/50 V	R8 (UHF OSC)	1 kΩ
C17 (VTU)	2.2 nF/50 V	R9 (UHF OSC)	2.2 k
C18(CP)	0.01 u/50 V	R10 (VTU)	3 kΩ
C19(CP)	22 pF/50 V	R11 (VTU)	20 kΩ
C20 (AIF OUT)	2.2 nF	R12 (CP)	47 kΩ
C21 (DIF OUT1)	2.2 nF	R15 (DIF OUT1)	200 Ω
C23 (DIF OUT2)	2.2 nF	R17 (DIF OUT2)	200 Ω
C26 (IF GCA IN1)	2.2 nF	R19 (DIF OUT2)	50 Ω
C28 (IF GCA IN2)	2.2 nF	R21 (DIF OUT1)	0
C30 (VCC)	0.1 uF	R23 (P5/ADC)	Open
C32 (IF GCA OUT1)	2.2 nF	R24 (IF GCA IN1)	(50 Ω)
C34 (IF GCA OUT2)	2.2 nF	R25 (IF GCA IN2)	0
C37 (UHF RF IN1)	2.2 nF	R28 (IF GCA OUT1)	200 Ω
C39 (UHF RFIN2)	2.2 nF	R30 (IF GCA OUT1)	50 Ω
C40 (VHI RF IN)	2.2 nF	R31 (IF GCA OUT2)	200 Ω
C42 (VLO RF IN)	2.2 nF	R34 (IF GCA OUT2)	0
C47 (MIX OUT)	6 pF	R36 (UHF RF IN1)	(50 Ω)
C49 (MIX OUT)	2.2 nF	R37 (VHI RF IN)	(50 Ω)
C51 (RF AGC OUT)	0.15 uF	R38 (VLO RF IN)	(50 Ω)
C52 (RF AGC BUF)	Open	R42 (MIX OUT)	0
C56 (IFGCA CTRL)	0.1 μF	R46 (IFGCA CTRL)	0
C57 (XTAL OUT)	0.01 uF	R47 (XTAL OUT)	5.1 kΩ
C58 (XTAL OUT)	10 pF	R48 (SDA)	330 Ω
C59(XTAL)	27 pF	R49 (SCL)	330 Ω
C60 (XTAL)	27 pF	R50 (AS)	Open
C61 (VCC)	2.2 nF	VC1 (VLO OSC)	MA2S374
C62 (SDA)	Open	VC2 (VHI OSC)	MA2S374
C63 (SCL)	Open	VC3 (UHF OSC)	MA2S372
C64 (AS)	Open	VC4 (VHI OSC)	MA2S372
C65 (AS)	22 pF	X1	4-MHz crystal

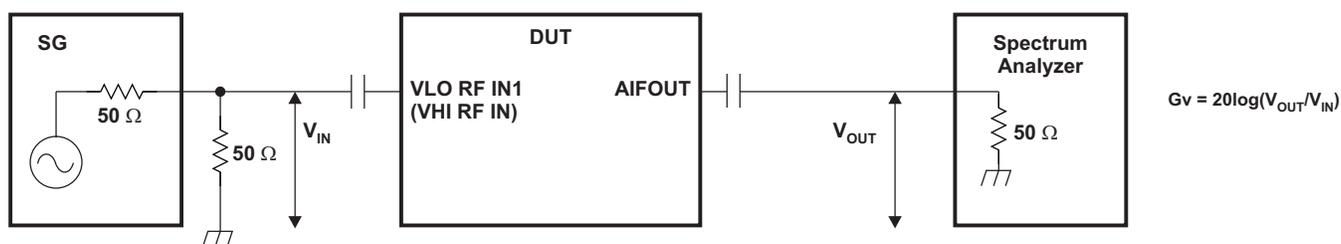
APPLICATION INFORMATION (CONTINUED)

Test Circuits



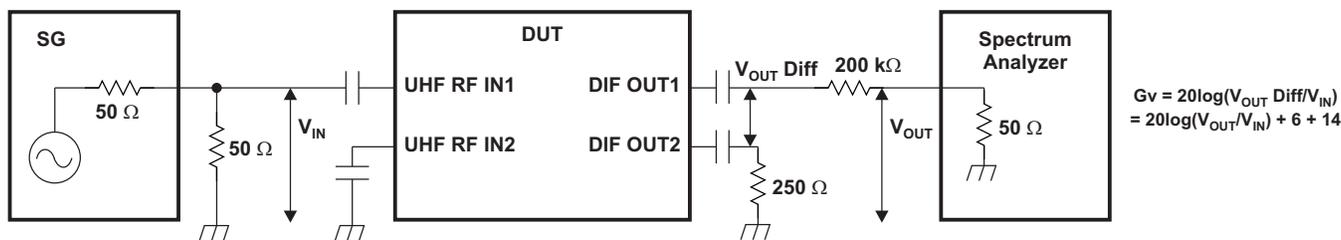
$$G_v = 20\log(V_{OUT\ Diff}/V_{IN}) = 20\log(V_{OUT}/V_{IN}) + 6 + 14$$

Figure 26. VHF-Conversion Gain-Measurement Circuit (at DIFOUT)



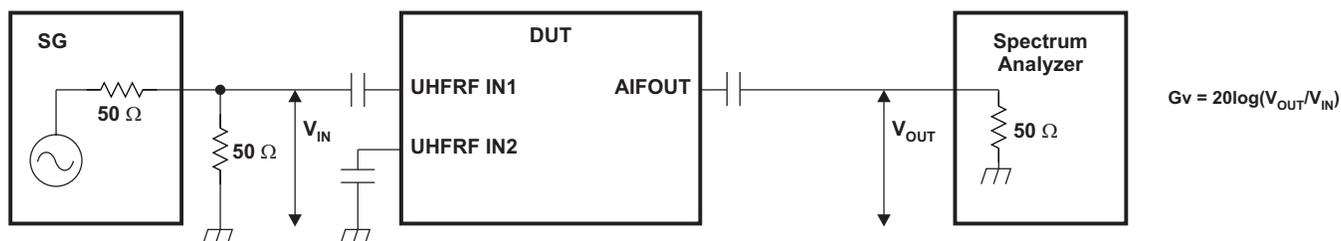
$$G_v = 20\log(V_{OUT}/V_{IN})$$

Figure 27. VHF-Conversion Gain Measurement Circuit (at AIFOUT)



$$G_v = 20\log(V_{OUT\ Diff}/V_{IN}) = 20\log(V_{OUT}/V_{IN}) + 6 + 14$$

Figure 28. UHF-Conversion Gain-Measurement Circuit (at DIFOUT)



$$G_v = 20\log(V_{OUT}/V_{IN})$$

Figure 29. UHF-Conversion Gain Measurement Circuit (at AIFOUT)

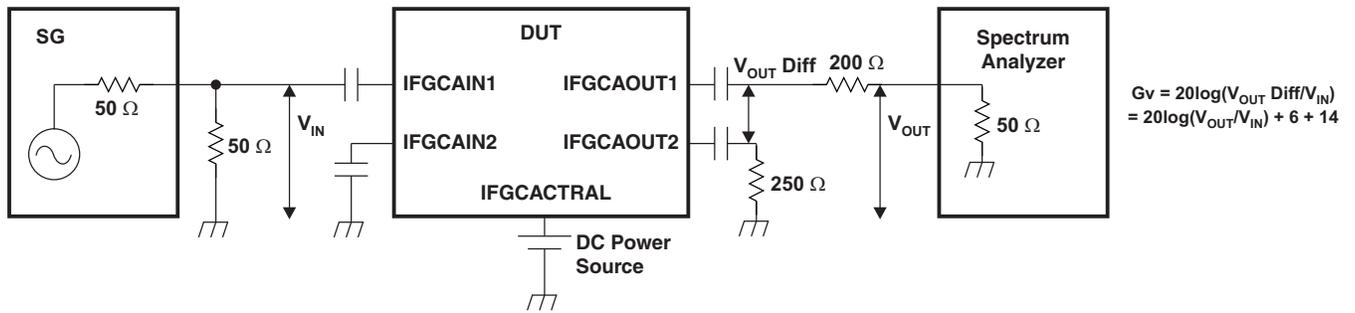


Figure 30. IF GCA Gain Measurement Circuit

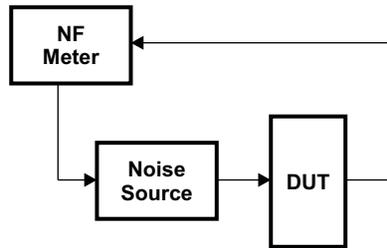


Figure 31. Noise-Figure Measurement Circuit

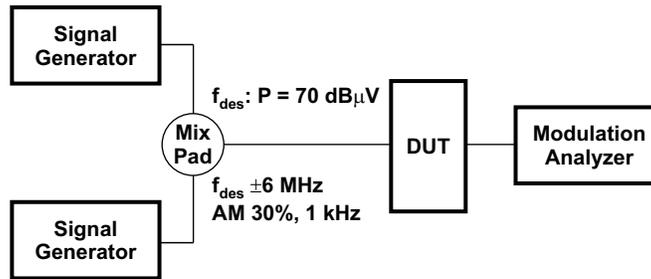


Figure 32. 1% Cross-Modulation Distortion Measurement Circuit

TYPICAL CHARACTERISTICS

Band Switch Driver Output Voltage (BS1–BS4)

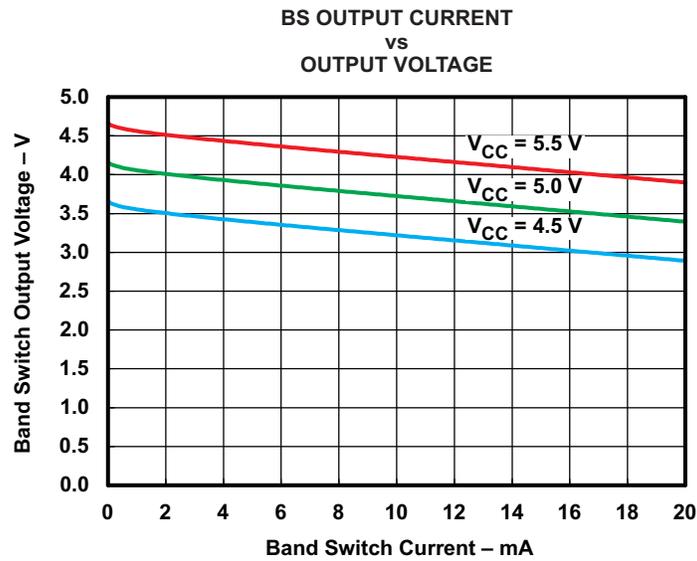


Figure 33. Band Switch Driver Output Voltage

S-Parameter

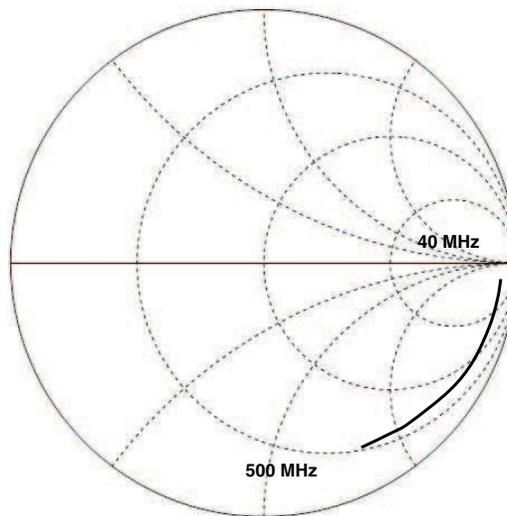


Figure 34. VLO RFIN, VHI RFIN

TYPICAL CHARACTERISTICS (continued)

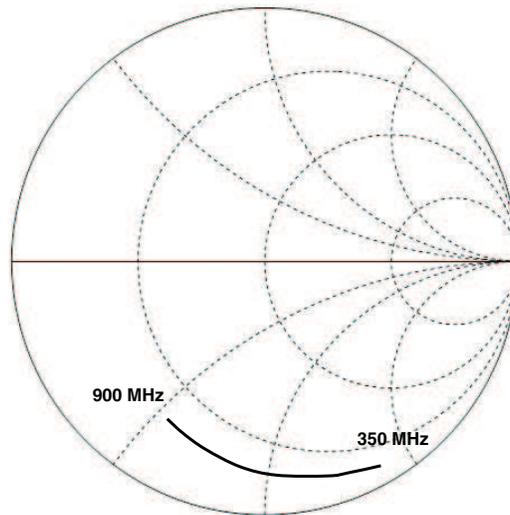


Figure 35. UHF RFIN

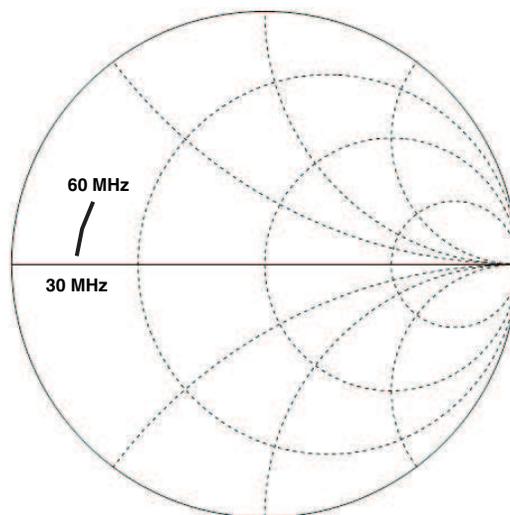


Figure 36. DIFOUT

TYPICAL CHARACTERISTICS (continued)

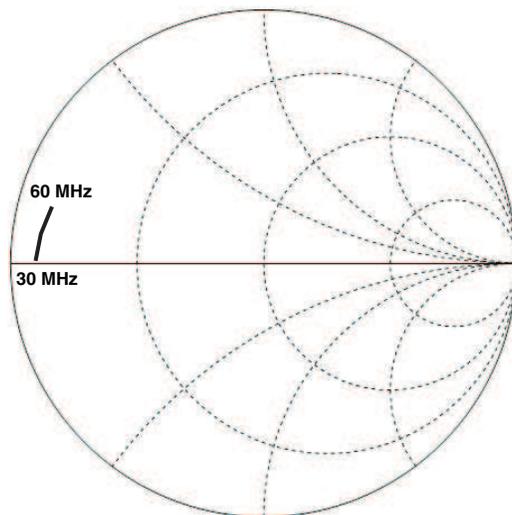


Figure 37. AIFOUT

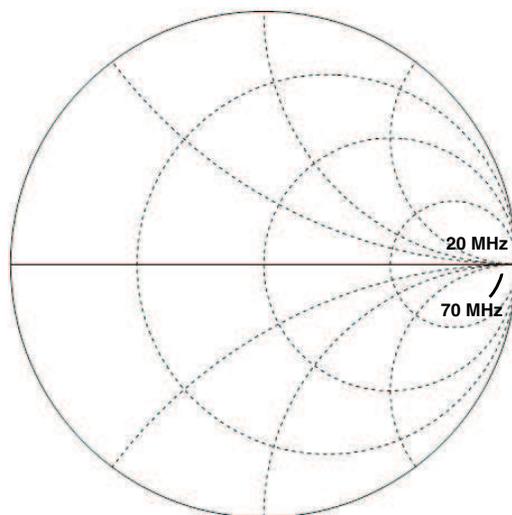


Figure 38. IF GCA IN

TYPICAL CHARACTERISTICS (continued)

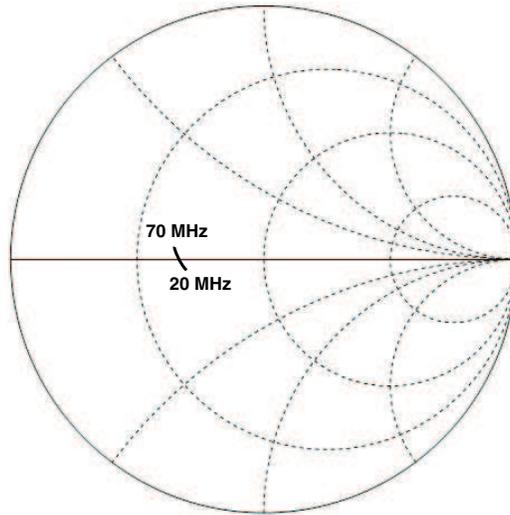


Figure 39. IF GCAOUT

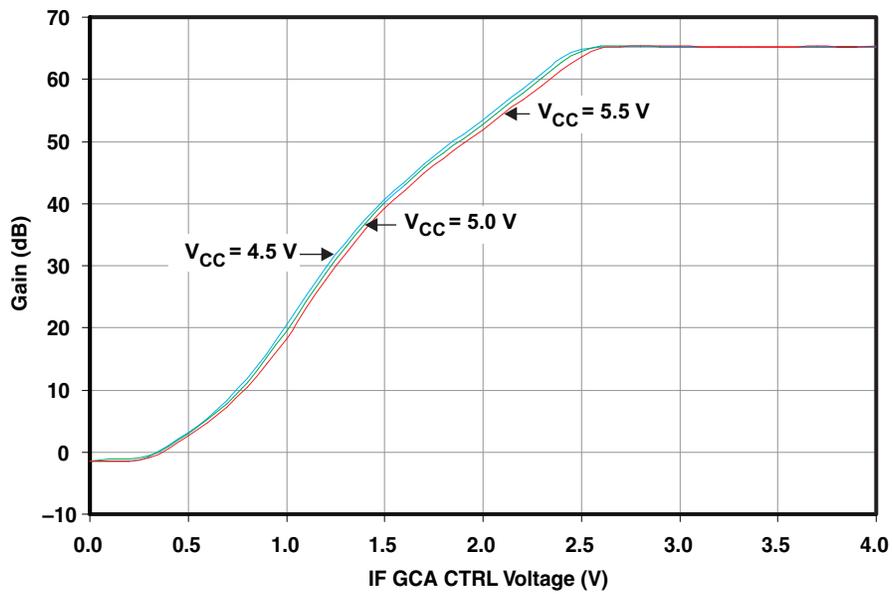


Figure 40. IF GCA Gain vs Control Voltage 1

TYPICAL CHARACTERISTICS (continued)

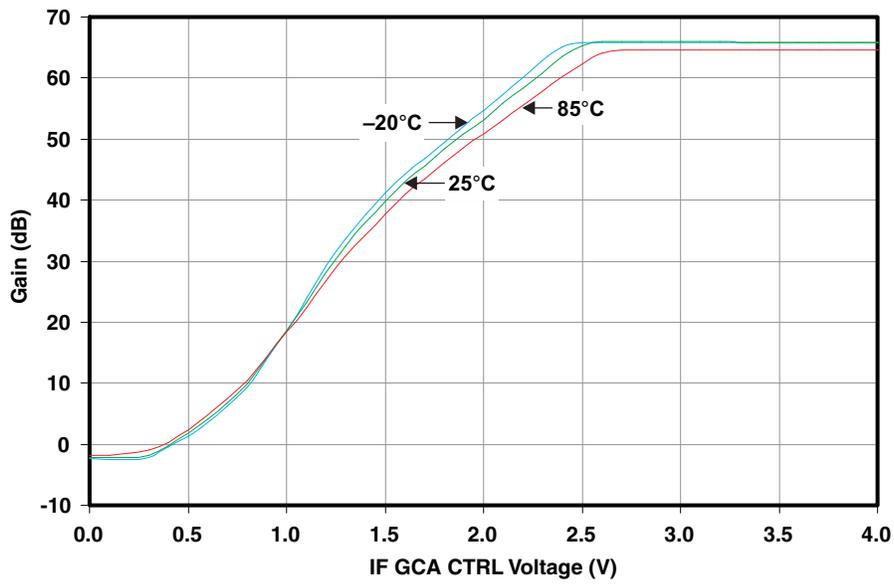


Figure 41. IF GCA Gain vs Control Voltage 2

**PACKAGING INFORMATION**

Orderable Device	Status <sup>(1)</sup>	Package Type	Package Drawing	Pins	Package Qty	Eco Plan <sup>(2)</sup>	Lead/Ball Finish	MSL Peak Temp <sup>(3)</sup>
SN761640DBTR	ACTIVE	TSSOP	DBT	44	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR

<sup>(1)</sup> The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

<sup>(2)</sup> Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

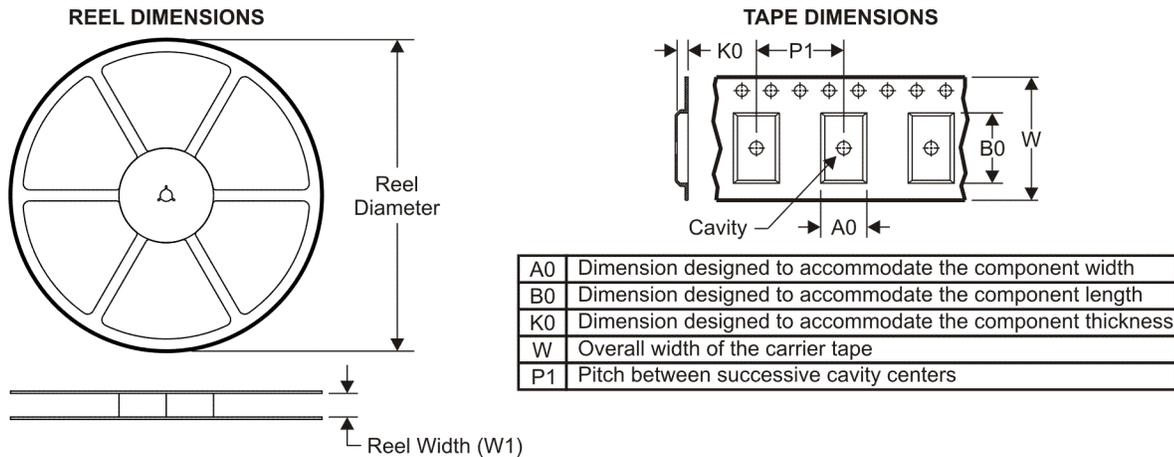
**Green (RoHS & no Sb/Br):** TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

<sup>(3)</sup> MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

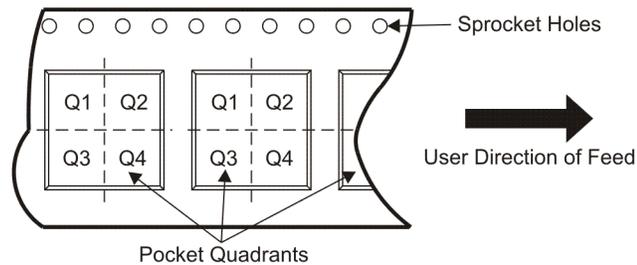
**Important Information and Disclaimer:**The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

## TAPE AND REEL INFORMATION



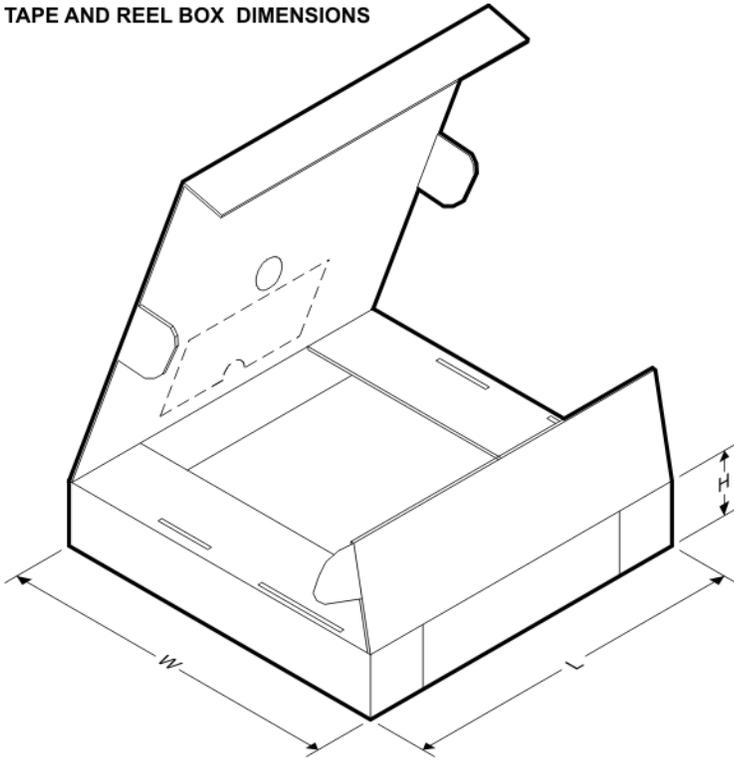
### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN761640DBTR	TSSOP	DBT	44	2000	330.0	24.4	6.8	11.7	1.6	12.0	24.0	Q1
SN761640DBTR	TSSOP	DBT	44	2000	330.0	24.4	6.8	11.7	1.6	12.0	24.0	Q1

**TAPE AND REEL BOX DIMENSIONS**



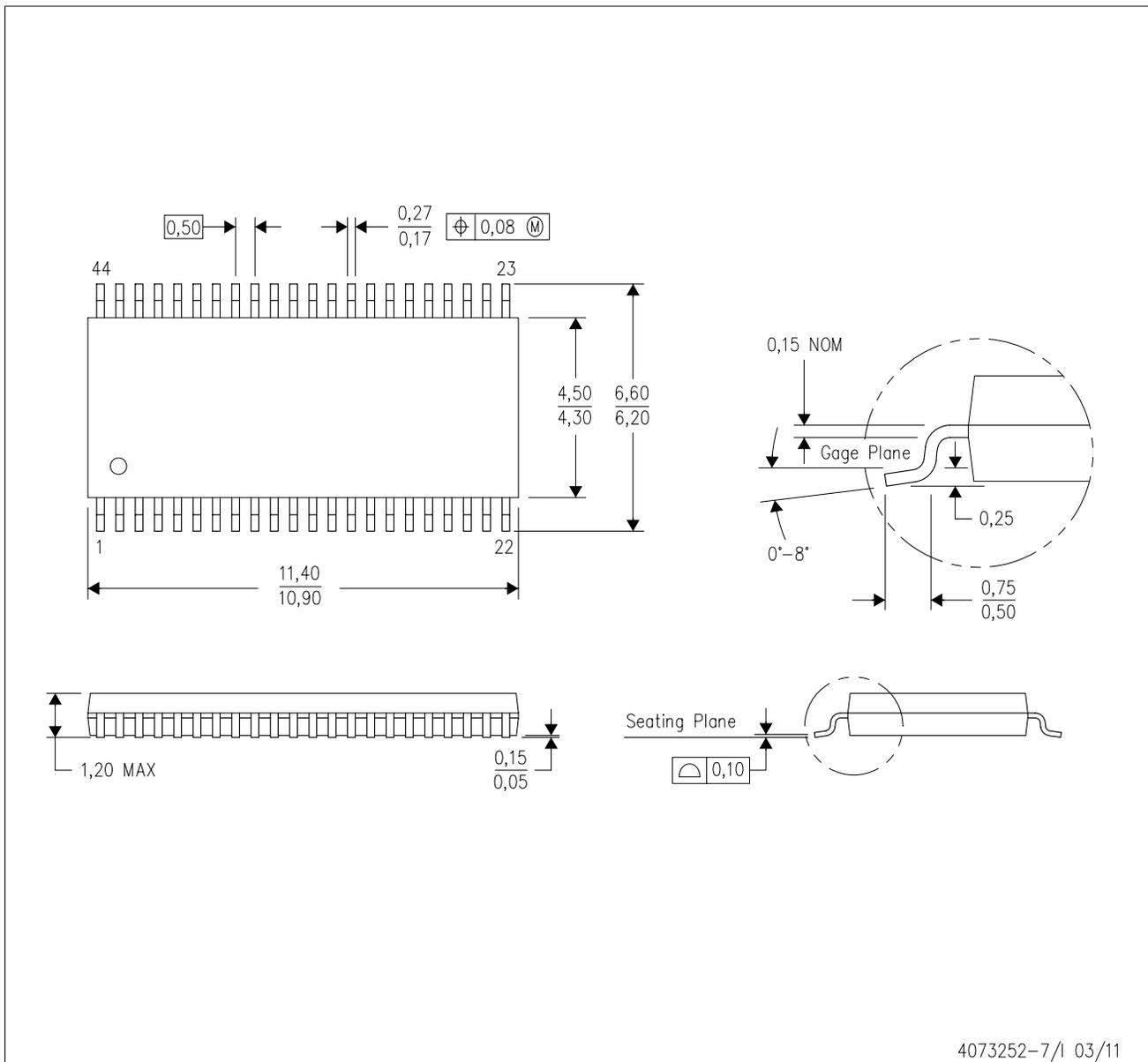
\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN761640DBTR	TSSOP	DBT	44	2000	346.0	346.0	41.0
SN761640DBTR	TSSOP	DBT	44	2000	346.0	346.0	41.0

# MECHANICAL DATA

DBT (R-PDSO-G44)

PLASTIC SMALL OUTLINE



- NOTES:
- A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.
  - B. This drawing is subject to change without notice.
  - C. Body dimensions do not include mold flash or protrusion.

## IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, modifications, enhancements, improvements, and other changes to its products and services at any time and to discontinue any product or service without notice. Customers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All products are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its hardware products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by government requirements, testing of all parameters of each product is not necessarily performed.

TI assumes no liability for applications assistance or customer product design. Customers are responsible for their products and applications using TI components. To minimize the risks associated with customer products and applications, customers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any TI patent right, copyright, mask work right, or other TI intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information published by TI regarding third-party products or services does not constitute a license from TI to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of TI information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. Reproduction of this information with alteration is an unfair and deceptive business practice. TI is not responsible or liable for such altered documentation. Information of third parties may be subject to additional restrictions.

Resale of TI products or services with statements different from or beyond the parameters stated by TI for that product or service voids all express and any implied warranties for the associated TI product or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

TI products are not authorized for use in safety-critical applications (such as life support) where a failure of the TI product would reasonably be expected to cause severe personal injury or death, unless officers of the parties have executed an agreement specifically governing such use. Buyers represent that they have all necessary expertise in the safety and regulatory ramifications of their applications, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of TI products in such safety-critical applications, notwithstanding any applications-related information or support that may be provided by TI. Further, Buyers must fully indemnify TI and its representatives against any damages arising out of the use of TI products in such safety-critical applications.

TI products are neither designed nor intended for use in military/aerospace applications or environments unless the TI products are specifically designated by TI as military-grade or "enhanced plastic." Only products designated by TI as military-grade meet military specifications. Buyers acknowledge and agree that any such use of TI products which TI has not designated as military-grade is solely at the Buyer's risk, and that they are solely responsible for compliance with all legal and regulatory requirements in connection with such use.

TI products are neither designed nor intended for use in automotive applications or environments unless the specific TI products are designated by TI as compliant with ISO/TS 16949 requirements. Buyers acknowledge and agree that, if they use any non-designated products in automotive applications, TI will not be responsible for any failure to meet such requirements.

Following are URLs where you can obtain information on other Texas Instruments products and application solutions:

### Products

Audio	<a href="http://www.ti.com/audio">www.ti.com/audio</a>
Amplifiers	<a href="http://amplifier.ti.com">amplifier.ti.com</a>
Data Converters	<a href="http://dataconverter.ti.com">dataconverter.ti.com</a>
DLP® Products	<a href="http://www.dlp.com">www.dlp.com</a>
DSP	<a href="http://dsp.ti.com">dsp.ti.com</a>
Clocks and Timers	<a href="http://www.ti.com/clocks">www.ti.com/clocks</a>
Interface	<a href="http://interface.ti.com">interface.ti.com</a>
Logic	<a href="http://logic.ti.com">logic.ti.com</a>
Power Mgmt	<a href="http://power.ti.com">power.ti.com</a>
Microcontrollers	<a href="http://microcontroller.ti.com">microcontroller.ti.com</a>
RFID	<a href="http://www.ti-rfid.com">www.ti-rfid.com</a>
RF/IF and ZigBee® Solutions	<a href="http://www.ti.com/lprf">www.ti.com/lprf</a>

### Applications

Communications and Telecom	<a href="http://www.ti.com/communications">www.ti.com/communications</a>
Computers and Peripherals	<a href="http://www.ti.com/computers">www.ti.com/computers</a>
Consumer Electronics	<a href="http://www.ti.com/consumer-apps">www.ti.com/consumer-apps</a>
Energy and Lighting	<a href="http://www.ti.com/energy">www.ti.com/energy</a>
Industrial	<a href="http://www.ti.com/industrial">www.ti.com/industrial</a>
Medical	<a href="http://www.ti.com/medical">www.ti.com/medical</a>
Security	<a href="http://www.ti.com/security">www.ti.com/security</a>
Space, Avionics and Defense	<a href="http://www.ti.com/space-avionics-defense">www.ti.com/space-avionics-defense</a>
Transportation and Automotive	<a href="http://www.ti.com/automotive">www.ti.com/automotive</a>
Video and Imaging	<a href="http://www.ti.com/video">www.ti.com/video</a>
Wireless	<a href="http://www.ti.com/wireless-apps">www.ti.com/wireless-apps</a>

TI E2E Community Home Page

[e2e.ti.com](http://e2e.ti.com)

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265  
Copyright © 2011, Texas Instruments Incorporated